# Digital FET, Dual N & P Channel

# FDG6321C

## **General Description**

These dual N & P-Channel logic level enhancement mode field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially on low voltage replacement for bipolar digital transistors and small signal MOSFETS. Since bias resistors are not required, this dual digital FET can replace several different digital transistors, with different bias resistor values.

## Features

- N-Ch 0.50 A, 25 V
  - $R_{DS(ON)} = 0.45 \Omega @ V_{GS} = 4.5 V$
  - $R_{DS(ON)} = 0.60 \Omega @ V_{GS} = 2.7 V$
- P-Ch -0.41 A, -25 V
  - $R_{DS(ON)} = 1.1 \Omega @ V_{GS} = -4.5 V$
  - $R_{DS(ON)} = 1.5 \Omega @ V_{GS} = -2.7 V$
- Very Small Package Outline SC70–6
- Very Low Level Gate Drive Requirements Allowing Direct Operation in 3 V Circuits (V<sub>GS(th)</sub> < 1.5 V)
- Gate-Source Zener for ESD Ruggedness (>6 kV Human Body Model)
- These Devices are Pb-Free and are RoHS Compliant

Symbol	Param	neter	N-Channel	P-Channel	Units				
V <sub>DSS</sub>	Drain-Source Voltage		25	-25	V				
V <sub>GSS</sub>	Gate-Source Voltage		8	-8	V				
I <sub>D</sub>	Drain Current Continuous		0.5	-0.41	А				
	Pulsed		1.5	-1.2					
P <sub>D</sub>	Maximum Power Dissipation (Note 1)		0.3		W				
T <sub>J</sub> , T <sub>STG</sub>	Operating and S Temperature Ra		–55 to 150		°C				
ESD	Electrostatic Dis Rating MIL–STI Human Body M 1500 Ω)	D-883D	(	6	kV				

## **ABSOLUTE MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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SC-88/SC70-6/SOT-363 CASE 419B-02





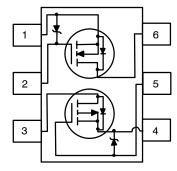
= Specific Device Code

21

М

= Assembly Operation Month

### PIN CONNECTIONS



## **ORDERING INFORMATION**

See detailed ordering and shipping information on page 8 of this data sheet.

## THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	415	°C/W

 R<sub>θJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>θJC</sub> is guaranteed by design while R<sub>θCA</sub> is determined by the user's board design. R<sub>θJA</sub> = 415°C/W on minimum pad mounting on FR-4 board in still air.

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS	•					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A	N-Ch	25	-	-	V
		$V_{GS}$ = 0 V, $I_D$ = –250 $\mu$ A	P-Ch	-25	-	-	
$\Delta \text{BV}_{\text{DSS}}  /  \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature	$I_D$ = 250 $\mu$ A, Referenced to 25°C	N-Ch	-	26	-	mV/°C
	Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$	P-Ch	-	-22	-	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch	-	-	1	μΑ
		$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 $^{\circ}C$		-	-	10	]
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	P-Ch	-	-	-1	μΑ
		$V_{DS}$ = –20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 $^{\circ}C$		-	-	-10	1
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{GS}$ = 8 V, $V_{DS}$ = 0 V	N-Ch	-	-	100	nA
		$V_{GS} = -8 V, V_{DS} = 0 V$	P-Ch	-	-	-100	1

#### **ON CHARACTERISTICS** (Note 2)

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	N-Ch	0.65	0.8	1.5	V
		$V_{DS}=V_{GS},\ I_{D}=-250\ \mu A$	P-Ch	-0.65	-0.82	-1.5	
$\Delta V_{GS(th)}  /  \Delta T_J$	Gate Threshold Voltage	$I_D$ = 250 µA, Referenced to 25°C	N-Ch	-	-2.6	-	mV/°C
	Temperature Coefficient	$I_D = -250 \ \mu A$ , Referenced to $25^{\circ}C$	P-Ch	-	2.1	-	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ = 4.5 V, I <sub>D</sub> = 0.5 A	N-Ch	-	0.34	0.45	Ω
		$V_{GS}$ = 4.5 V, $I_D$ = 0.5 A, $T_J$ = 125 $^\circ C$		-	0.55	0.72	
		$V_{GS}$ = 2.7 V, I <sub>D</sub> = 0.2 A		-	0.44	0.6	
		$V_{GS}$ = -4.5 V, I <sub>D</sub> = -0.41 A	P-Ch	-	0.85	1.1	1
		$V_{GS}$ = -4.5 V, I <sub>D</sub> = -0.41 A, T <sub>J</sub> = 125°C		-	1.2	1.8	
		$V_{GS}$ = -2.7 V, I <sub>D</sub> = -0.05 A		-	1.15	1.5	
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS}$ = 4.5 V, $V_{DS}$ = 5 V	N-Ch	0.5	-	-	А
		$V_{GS}$ = -4.5 V, $V_{DS}$ = -5 V	P-Ch	-0.41	-	-	1
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	N-Ch	-	1.45	-	S
		$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -0.41 \text{ A}$	P-Ch	-	0.9	-	1

## DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	N-Channel	N-Ch	-	50	-	pF
			P-Ch	1	62	I	
C <sub>oss</sub>	Output Capacitance	P–Channel V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V,	N-Ch	-	28	-	
		f = 1.0 MHz	P-Ch	-	34	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		N-Ch	-	9	-	
			P-Ch	-	10	-	

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted) (continued)

Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Unit
SWITCHING C	HARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn-On Delay Time	N-Channel	N-Ch	-	3	6	ns
		$V_{DD}$ = 5 V, I <sub>D</sub> = 0.5 A, V <sub>GS</sub> = 4.5 V, R <sub>GEN</sub> = 50 Ω	P-Ch	-	7	15	1
t <sub>r</sub>	Turn-On Rise Time	P-Channel	N-Ch	-	8.5	18	ns
		$V_{DD} = -5 \text{ V}, \text{ I}_D = -0.5 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 50 \Omega$	P-Ch	-	8	16	
t <sub>D(off)</sub>	Turn-Off Delay Time	$V_{GS} = -4.5 \text{ V},  \text{h}_{GEN} = 50.52$	N-Ch	-	17	30	ns
			P-Ch	-	55	80	
t <sub>f</sub>	Turn-Off Fall Time		N-Ch	-	13	25	ns
			P-Ch	-	35	60	
Qg	Total Gate Charge	N-Channel	N-Ch	-	1.64	2.3	nC
		$V_{DS} = 5 V, I_D = 0.5 A, V_{GS} = 4.5 V$	P-Ch	-	1.1	1.5	
Q <sub>gs</sub>	Gate-Source Charge	P-Channel	N-Ch	-	0.38	-	nC
		$V_{DS} = -5 \text{ V}, \text{ I}_D = -0.41 \text{ A},$ $V_{GS} = -4.5 \text{ V}$	P-Ch	-	0.31	-	
Q <sub>gd</sub>	Gate-Drain Charge	$V_{GS} = -4.5 V$	N-Ch	-	0.45	-	nC
			P-Ch	-	0.29	-	1

#### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		N-Ch	-	-	0.25	А
			P-Ch	-	-	-0.25	
V <sub>SD</sub>	Drain-Source Diode Forward	$V_{GS}$ = 0 V, $I_{S}$ = 0.5 A (Note 2)	N-Ch	-	0.8	1.2	V
	Voltage	$V_{GS}$ = 0 V, $I_{S}$ = –0.5 A (Note 2)	P-Ch	-	-0.8	-1.2	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

## **TYPICAL PERFORMANCE CHARACTERISTICS: N-CHANNEL**

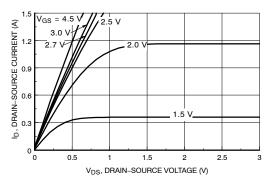


Figure 1. On–Region Characteristics

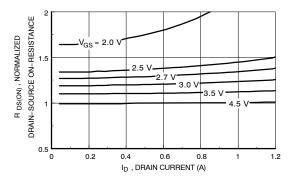


Figure 2. On–Resistance Variation with Drain Current and Gate Voltage

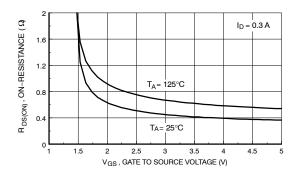


Figure 4. On–Resistance Variation with Gate–to–Source Voltage

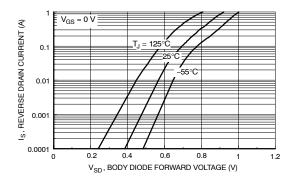


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

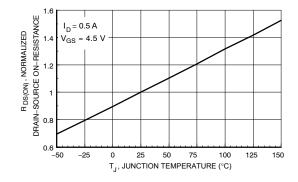


Figure 3. On–Resistance Variation with Temperature

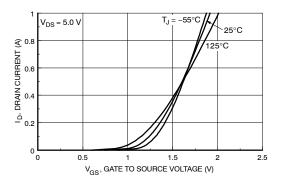


Figure 5. Transfer Characteristics

## TYPICAL PERFORMANCE CHARACTERISTICS: N-CHANNEL (continued)

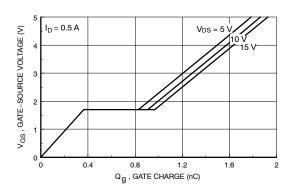


Figure 7. Gate Charge Characteristics

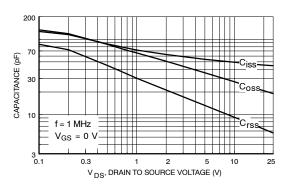


Figure 8. Capacitance Characteristics

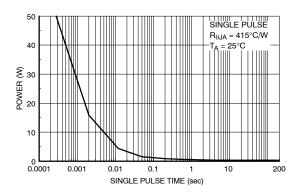


Figure 10. Single Pulse Maximum Power Dissipation

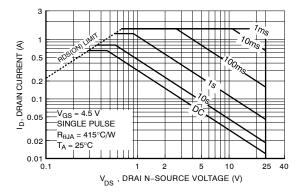


Figure 9. Maximum Safe Operating Area

## **TYPICAL PERFORMANCE CHARACTERISTICS: P-CHANNEL**

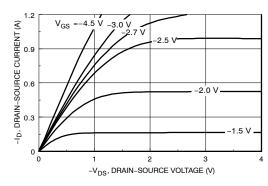


Figure 11. On-Region Characteristics

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V<sub>GS</sub>

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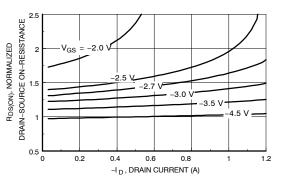


Figure 12. On–Resistance Variation with Drain Current and Gate Voltage

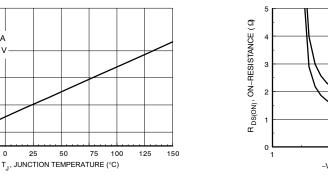


Figure 13. On–Resistance Variation with Temperature

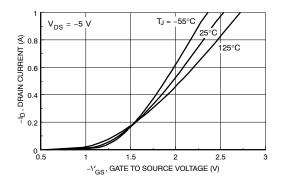


Figure 15. Transfer Characteristics

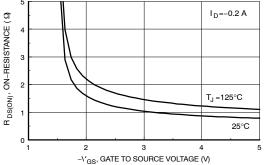


Figure 14. On–Resistance Variation with Gate–to–Source Voltage

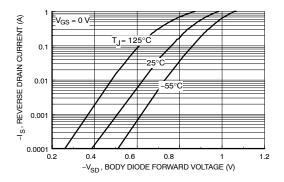


Figure 16. Body Diode Forward Voltage Variation with Source Current and Temperature

## TYPICAL PERFORMANCE CHARACTERISTICS: P-CHANNEL (continued)

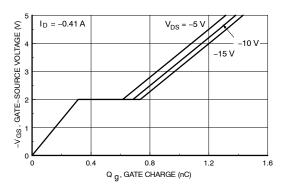


Figure 17. Gate Charge Characteristics

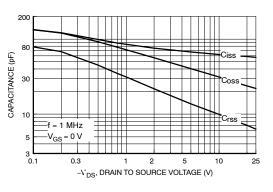


Figure 18. Capacitance Characteristics

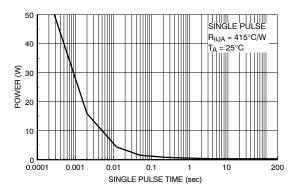


Figure 20. Single Pulse Maximum Power Dissipation

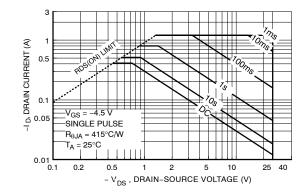
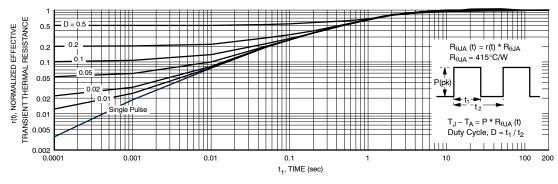


Figure 19. Maximum Safe Operating Area

## **TYPICAL PERFORMANCE CHARACTERISTICS: N & P-CHANNEL**



Thermal characterization performed using the conditions described in Note 1. Transient thermal response will change depending on the circuit board design.

#### Figure 21. Transient Thermal Response Curve

## **ORDERING INFORMATION**

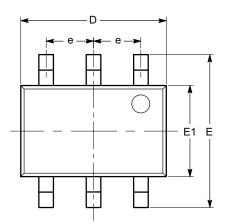
Device Order Number	Device Marking	Package Type	Shipping <sup>†</sup>
FDG6321C	21	SC-88/SC70-6/SOT-363 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

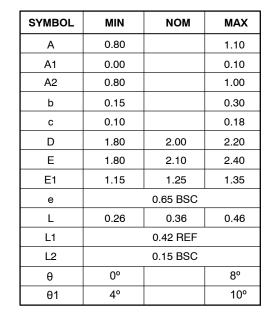


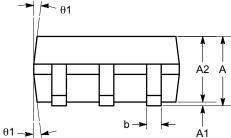
#### SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD-01 ISSUE A

DATE 07 JUL 2010









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END VIEW

#### Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

SIDE VIEW

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